G383-R80-AAP1

HPC/AI Server - 3U AMD Instinct™ MI300A APU





Features

- 4 x AMD Instinct™ MI300A APUs
- 128GB HBM3 per APU
- Dual ROM Architecture
- 2 x 10Gb/s LAN ports via Broadcom® BCM57416
- 1 x M.2 slot with PCIe Gen5 x4 interface
- 8 x 2.5" Gen5 NVMe bays
- 4 x FHFL Dual slot PCIe Gen5 x16 slots
- 4 x FHFL Single slot PCle Gen5 x16 slots
- 3+1 3000W 80 PLUS Titanium redundant power supplies

AMD Instinct™ MI300A APU

228 AMD CDNA™ 3 GPU compute units and 24 AMD "Zen 4" x86 CPU cores

AMD Instinct MI300A accelerated processing units (APUs) combine the power of AMD Instinct accelerators and AMD EPYC™ processors with shared memory to enable enhanced efficiency, flexibility, and programmability. They are designed to accelerate the convergence of AI and HPC, helping advance research and propel new discoveries.

128GB HBM3

with 5.3 TB/s peak memory bandwith

Up to **122.6 TFLOPS**

peak theoretical single precision (FP32) HPC performance

Up to 61.3 TFLOPS

peak theoretical double precision (FP64) HPC performance

3.9 PFLOPS

peak theoretical 8-bit precision (FP8) with sparsity for AI performance



G383-R80-AAP1 Specification

| Dimensions | 3U (W447 x H131 x D950 mm) | I/O ports | Front: 2 x USB 3.2 Gen1, 1 x VGA, 2 x RJ45, 1 x MLAN Rear: N/A |
|--------------------|---|-------------------------|---|
| APU | 4 x AMD Instinct™ MI300A APUs - 24 x Zen4 CPU cores per APU - 228 x CDNA3 compute units per APU - TDP up to 550W (CPU + GPU + memory) - Peak up to 760W | Backplane Board | Speed and bandwidth: PCle Gen5 x4 |
| | | Security Modules | 1 x TPM header with SPI interface - Optional TPM2.0 kit: CTM010 |
| Socket | 4 x Socket SH5 | Power Supply | 3+1 3000W 80 PLUS Titanium redundant power supplies AC Input: 100-240V *The system power supply requires C19 power cord. |
| Chipset | System on Chip | | |
| Memory | 128GB HBM3 unified memory Memory bandwidth 5.3TB/s | System Management | ASPEED® AST2600 Baseboard Management Controller GIGABYTE Management Console web interface |
| LAN | 2 x 10Gb/s LAN ports (1 x Broadcom® BCM57416) Support NCSI function 1 x 10/100/1000 Mbps Management LAN | System Fans | 2 x 60x60x56mm (25,700rpm), 8 x 80x80x80mm (16,500rpm) |
| | | Operating Properties | Operating temperature: 10°C to 35°C Operating humidity: 8%-80% (non-condensing) Non-operating temperature: -40°C to 60°C Non-operating humidity: 20%-95% (non-condensing) |
| Video | Integrated in ASPEED® AST2600 - 1 x VGA port | | |
| Storage | 8 x 2.5" Gen5 NVMe bays 1 x M.2 slot (PCIe Gen5 x4, 2280/22110) | Packaging Content | 1 x G383-R80-AAP1, 4 x APU heatsinks, 1 x L-shape Rail kit |
| Expansion Slots | 4 x FHFL Dual slot PCle Gen5 x16 slots 4 x FHFL Single slot PCle Gen5 x16 slots | Part Numbers | Barebone package: 6NG383R80DR000AAP1* |



Learn more at https://www.GIGABYTE.com/enterprise

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